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FIRST NAMED INVENTOR ATTORNEY DOCKET NO. CONFIRMATION NO. APPLICATION NO. FILING DATE 10/827,348 04/20/2004 Chan-bong Jun 277/038 EXAMINER 7590 02/22/2006 LEE & STERBA, P.C. SUMMONS, BARBARA **Suite 2000** ART UNIT PAPER NUMBER 1101 Wilson Boulevard Arlington, VA 22209 2817

DATE MAILED: 02/22/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

			H.H
	Application No.	Applicant(s)	
Office Action Summary	10/827,348	JUN ET AL.	
	Examiner	Art Unit	
	Barbara Summons	· 2817	
The MAILING DATE of this communication a Period for Reply	appears on the cover sheet w	vith the correspondence address	
A SHORTENED STATUTORY PERIOD FOR REI WHICHEVER IS LONGER, FROM THE MAILING  Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication.  If NO period for reply is specified above, the maximum statutory peri Failure to reply within the set or extended period for reply will, by sta Any reply received by the Office later than three months after the may earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNI 1.136(a). In no event, however, may a iod will apply and will expire SIX (6) MO tute, cause the application to become A	CATION. reply be timely filed  NTHS from the mailing date of this communicat BANDONED (35 U.S.C. § 133).	
Status			
1) Responsive to communication(s) filed on <u>08</u>	<u>3 December 2005</u> .		
2a)⊠ This action is <b>FINAL</b> . 2b)☐ T	his action is non-final.		
3) Since this application is in condition for allow			is
closed in accordance with the practice unde	er Ex parte Quayle, 1935 C.I	D. 11, 453 O.G. 213.	
Disposition of Claims			
4) Claim(s) 1-20 is/are pending in the application	on.		
4a) Of the above claim(s) is/are without	Irawn from consideration.		
5)⊠ Claim(s) <u>6-20</u> is/are allowed.		·	
6)⊠ Claim(s) <u>1 and 2</u> is/are rejected.			
7)⊠ Claim(s) <u>3-5</u> is/are objected to.			
8) Claim(s) are subject to restriction and	d/or election requirement.		
Application Papers			
9) The specification is objected to by the Exam	iner.		
10) The drawing(s) filed on is/are: a) a	accepted or b) objected to	by the Examiner.	
Applicant may not request that any objection to t	he drawing(s) be held in abeya	nce. See 37 CFR 1.85(a).	
Replacement drawing sheet(s) including the corn	rection is required if the drawing	g(s) is objected to. See 37 CFR 1.12	l(d).
11) The oath or declaration is objected to by the	Examiner. Note the attached	d Office Action or form PTO-152.	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of:  1. Certified copies of the priority docume 2. Certified copies of the priority docume 3. Copies of the certified copies of the papplication from the International Bur * See the attached detailed Office action for a	ents have been received. ents have been received in a priority documents have been eau (PCT Rule 17.2(a)).	Application No n received in this National Stage	
Attachment(s)  1) Motice of References Cited (PTO-892)	4) ☐ Interview	Summary (PTO-413)	
<ul> <li>2) Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/</li> </ul>		(s)/Mail Date Informal Patent Application (PTO-152)	
Paper No(s)/Mail Date	6) Other: _		

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#### **DETAILED ACTION**

## Withdrawn Claim Rejections - 35 USC § 102

1. Applicant's arguments, at section D. of the amendment, filed 12/8/05, with respect to the Fukuda et al. reference have been fully considered and are persuasive because the Examiner agrees that the "buried" resistance layer 32 of Fukuda et al. is not "formed on a surface of the semiconductor substrate". The rejection of claims 1-3 based on Fukuda et al. has been withdrawn.

# Maintained Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. § 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claims 1 and 2 are rejected under 35 U.S.C. § 102(b) as being anticipated by Barber et al. U.S. 6,486,751 (of record) for reasons of record mostly repeated below.

Fig. 6 of Barber et al. discloses a film bulk acoustic resonator (e.g. 60 in Fig. 11) comprising: a semiconductor substrate 12 (see e.g. col. 3, lines 24-25) that has a predetermined thickness; a first resistance layer 36 formed on a surface of the semiconductor substrate, the first resistance layer 36 having a recess 30; a membrane layer 32 formed on the first resistance layer 36 and over the recess 30, thereby forming in the recess an air gap region of the acoustic resonator; a first electrode 18 formed on the membrane layer 32; a piezoelectric layer 20 formed on the membrane layer and an

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exposed portion of the first electrode 18 being the whole first electrode 18; and a second electrode 14 formed on the piezoelectric layer 20.

## Allowable Subject Matter

- 4. Claims 6-20 are allowable over the prior art of record.
- 5. Claims 3-5 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

### Response to Arguments

6. Applicant's arguments filed 23/8/05 concerning the Barber et al. reference have been fully considered but they are deemed not persuasive.

Applicants argue that the air gap formed in the recess in Barber et al. is formed "by entirely removing the material of high resistivity layer 36" (see the amendment at page 9, the last three lines thereof) while the air gap of the invention is "formed in the recess in the first resistance layer and separated from the substrate" (see the amend. at page 10, lines 3-6). This argument is not persuasive for two reasons. Firstly, the argument is not commensurate with the scope of the claims since there is nothing in the claims requiring that the air gap be "separated from the substrate". Secondly, Applicants clearly indicate in their specification, that the "recess" can be formed by removing the entire resistance layer in such a way that the recess extends to the semiconductor substrate (see the spec. at page 11, lines 1-2 and page 7, lines 2-3 and 8-11). Applicants appear to be arguing the merits of claim 5, which was not rejected.

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#### Conclusion

7. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

8. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Nakatani et al. U.S. 6,732415 provides evidence that recesses extending all the way to the supporting substrate are art recognized equivalents of recesses that do not extend all the way to the substrate so that they have a bottom within the resistance layer (see Fig. 6F vs. Fig. 7), and Nakatani also discloses advantages of recesses with bottoms within the resistance layer (see col. 7, lines 24-29).

9. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Barbara Summons whose telephone number is (571) 272-1771. The examiner can normally be reached on M-Th, M-Fr.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Bob Pascal can be reached on (571) 271-1769. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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February 16, 2006

BARBARA SUMMONS
PRIMARY EXAMINER